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FCB20N60F

N-Channel SuperFET® FRFET® MOSFET

600 V, 20 A, 190 mΩ

Features

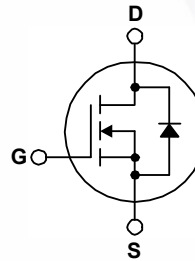
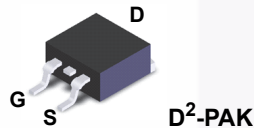
- 650 V @ $T_J = 150^\circ\text{C}$
- Typ. $R_{DS(on)} = 150\text{ m}\Omega$
- Ultra Low Gate Charge (Typ. $Q_g = 75\text{ nC}$)
- Low Effective Output Capacitance (Typ. $C_{oss,eff} = 165\text{ pF}$)
- 100% Avalanche Tested
- RoHS Compliant

Applications

- Lighting
- AC-DC Power Supply
- Solar Inverter

Description

SuperFET® MOSFET is Fairchild Semiconductor's first generation of high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications. SuperFET FRFET® MOSFET's optimized body diode reverse recovery performance can remove additional component and improve system reliability.



MOSFET Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | FCB20N60FTM | Unit |
|----------------|---|--|---------------------------|
| V_{DSS} | Drain to Source Voltage | 600 | V |
| I_D | Drain Current | - Continuous ($T_C = 25^\circ\text{C}$) | 20 |
| | | - Continuous ($T_C = 100^\circ\text{C}$) | 12.5 |
| I_{DM} | Drain Current | 60 | A |
| | | (Note 1) | |
| V_{GSS} | Gate to Source Voltage | ± 30 | V |
| E_{AS} | Single Pulsed Avalanche Energy | 690 | mJ |
| | | (Note 2) | |
| I_{AR} | Avalanche Current | 20 | A |
| | | (Note 1) | |
| E_{AR} | Repetitive Avalanche Energy | 20.8 | mJ |
| | | (Note 1) | |
| dv/dt | Peak Diode Recovery dv/dt | 50 | V/ns |
| | | (Note 3) | |
| P_D | Power Dissipation | ($T_C = 25^\circ\text{C}$) | 208 |
| | | - Derate above 25°C | 1.67 |
| | | | $\text{W}/^\circ\text{C}$ |
| T_J, T_{STG} | Operating and Storage Temperature Range | -55 to +150 | $^\circ\text{C}$ |
| T_L | Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds | 300 | $^\circ\text{C}$ |

Thermal Characteristics

| Symbol | Parameter | FCB20N60FTM | Unit |
|-----------------|--|-------------|---------------------------|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case, Max. | 0.6 | $^\circ\text{C}/\text{W}$ |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient (minimum pad of 2 oz copper), Max. | 62.5 | |
| | Thermal Resistance, Junction to Ambient (1 in ² pad of 2 oz copper), Max. | 40 | |

Package Marking and Ordering Information

| Device Marking | Device | Package | Reel Size | Tape Width | Quantity |
|----------------|-------------|---------------------|-----------|------------|----------|
| FCB20N60F | FCB20N60FTM | D ² -PAK | 330mm | 24m | 800 |

Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|--------|-----------|-----------------|------|------|------|------|
|--------|-----------|-----------------|------|------|------|------|

Off Characteristics

| | | | | | | |
|---|---|--|-----|-----|-----------|---------------|
| BV _{DSS} | Drain to Source Breakdown Voltage | V _{GS} = 0 V, I _D = 250 μA , T _C = 25°C | 600 | - | - | V |
| | | V _{GS} = 0 V, I _D = 250 μA , T _C = 150°C | - | 650 | - | V |
| $\Delta\text{BV}_{\text{DSS}} / \Delta T_J$ | Breakdown Voltage Temperature Coefficient | I _D = 250 μA , Referenced to 25°C | - | 0.6 | - | V/°C |
| BV _{DS} | Drain-Source Avalanche Breakdown Voltage | V _{GS} = 0 V, I _D = 20 A | - | 700 | - | V |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} = 600 V, V _{GS} = 0 V | - | - | 1 | μA |
| | | V _{DS} = 480 V, V _{GS} = 0 V, T _C = 125°C | - | - | 10 | |
| I _{GSS} | Gate to Body Leakage Current | V _{GS} = ± 30 V, V _{DS} = 0 V | - | - | ± 100 | nA |

On Characteristics

| | | | | | | |
|---------------------|--------------------------------------|--|-----|------|------|----------|
| V _{GS(th)} | Gate Threshold Voltage | V _{GS} = V _{DS} , I _D = 250 μA | 3.0 | - | 5.0 | V |
| R _{DS(on)} | Static Drain to Source On Resistance | V _{GS} = 10 V, I _D = 10 A | - | 0.15 | 0.19 | Ω |
| g _{FS} | Forward Transconductance | V _{DS} = 40 V, I _D = 10 A | - | 17 | - | S |

Dynamic Characteristics

| | | | | | | |
|-----------------------|------------------------------|--|---|------|------|----|
| C _{iss} | Input Capacitance | V _{DS} = 25 V, V _{GS} = 0 V f = 1.0 MHz | - | 2370 | 3080 | pF |
| C _{oss} | Output Capacitance | | - | 1280 | 1665 | pF |
| C _{riss} | Reverse Transfer Capacitance | | - | 95 | - | pF |
| C _{oss} | Output Capacitance | V _{DS} = 480 V, V _{GS} = 0 V, f = 1.0 MHz | - | 65 | 85 | pF |
| C _{oss,eff.} | Effective Output Capacitance | V _{DS} = 0 V to 400 V, V _{GS} = 0 V | - | 165 | - | pF |

Switching Characteristics

| | | | | | | | |
|---------------------|-------------------------------|--|---|------|-----|-----|----|
| t _{d(on)} | Turn-On Delay Time | V _{DD} = 300 V, I _D = 20 A R _G = 25 Ω | - | 62 | 135 | ns | |
| t _r | Turn-On Rise Time | | - | 140 | 290 | ns | |
| t _{d(off)} | Turn-Off Delay Time | | - | 230 | 470 | ns | |
| t _f | Turn-Off Fall Time | | (Note 4) | - | 65 | 140 | ns |
| Q _{g(tot)} | Total Gate Charge at 10V | | V _{DS} = 480 V, I _D = 20 A, V _{GS} = 10 V | - | 75 | 98 | nC |
| Q _{gs} | Gate to Source Gate Charge | (Note 4) | - | 13.5 | 18 | nC | |
| Q _{gd} | Gate to Drain "Miller" Charge | | - | 36 | - | nC | |

Drain-Source Diode Characteristics

| | | | | | | |
|-----------------|--|---|---|-----|-----|---------------|
| I _S | Maximum Continuous Drain to Source Diode Forward Current | - | - | 20 | A | |
| I _{SM} | Maximum Pulsed Drain to Source Diode Forward Current | - | - | 60 | A | |
| V _{SD} | Drain to Source Diode Forward Voltage | V _{GS} = 0 V, I _{SD} = 20 A | - | - | 1.4 | V |
| t _{rr} | Reverse Recovery Time | V _{GS} = 0 V, I _{SD} = 20 A | - | 160 | - | ns |
| Q _{rr} | Reverse Recovery Charge | di _F /dt = 100 A/ μs | - | 1.1 | - | μC |

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. I_{AS} = 10 A, V_{DD} = 50 V, R_G = 25 Ω , Starting T_J = 25°C
3. I_{SD} \leq 20 A, di/dt \leq 1200 A/ μs , V_{DD} \leq BV_{DSS}, Starting T_J = 25°C
4. Essentially Independent of Operating Temperature Typical Characteristics

Typical Performance Characteristics

Figure 1. On-Region Characteristics

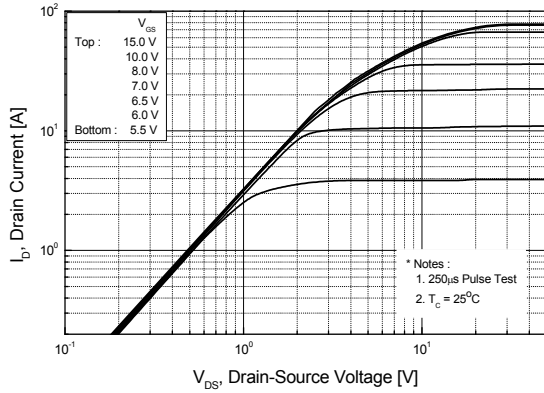


Figure 2. Transfer Characteristics

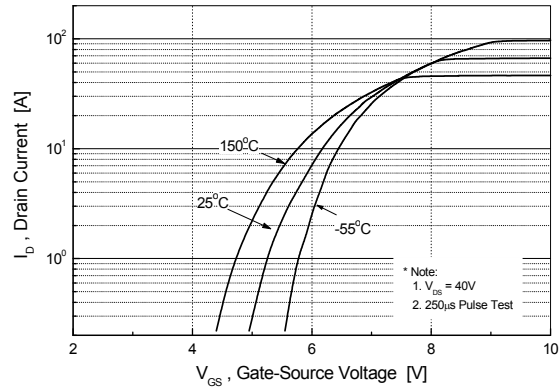


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

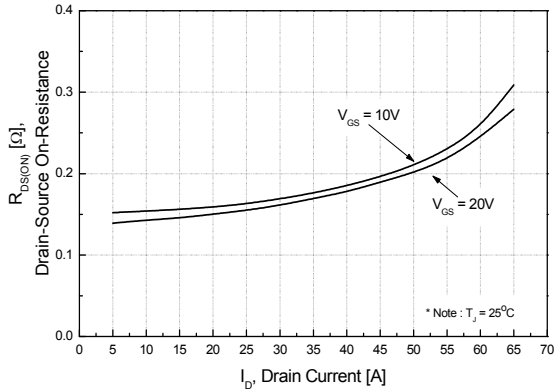


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

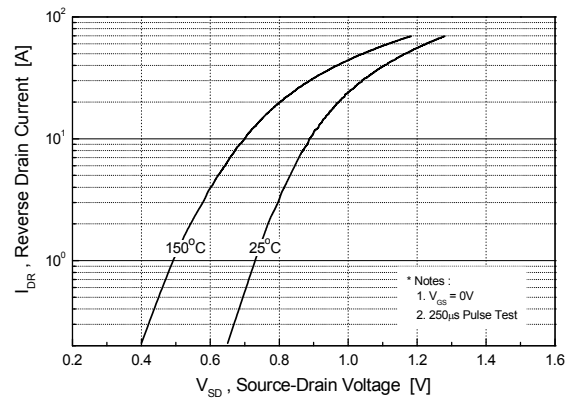


Figure 5. Capacitance Characteristics

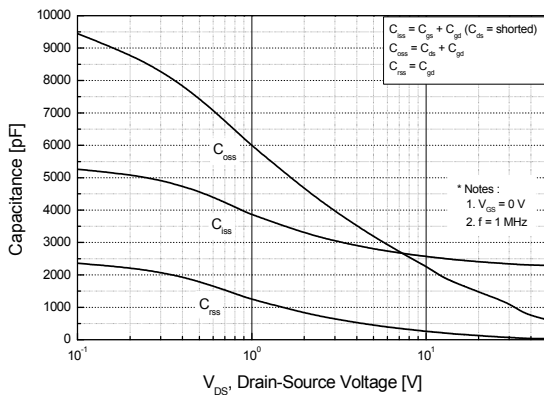
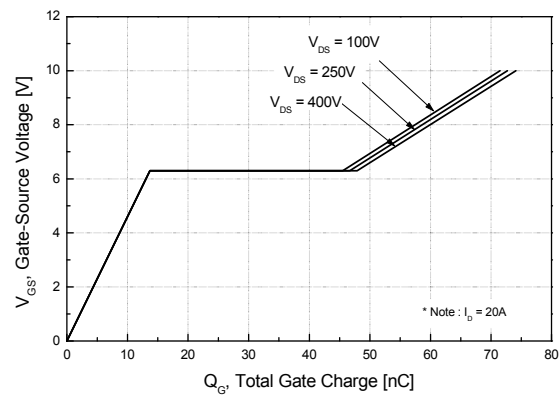


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

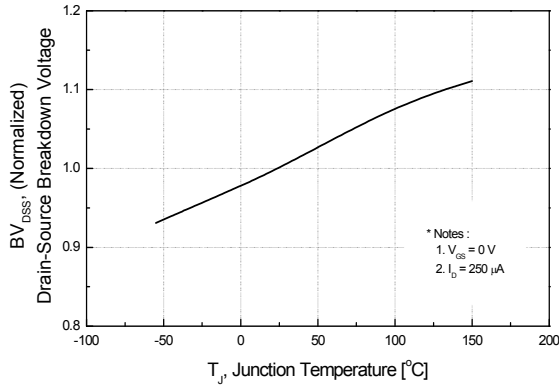


Figure 8. On-Resistance Variation vs. Temperature

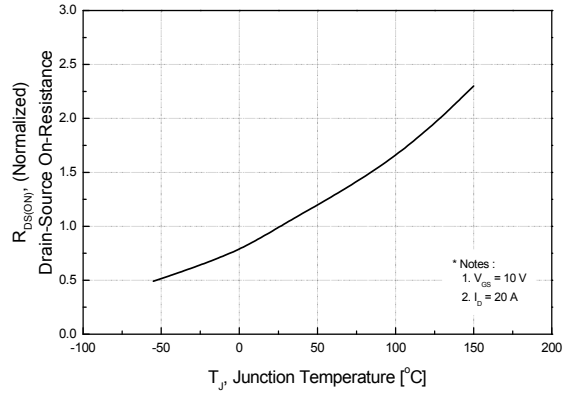


Figure 9. Maximum Safe Operating Area

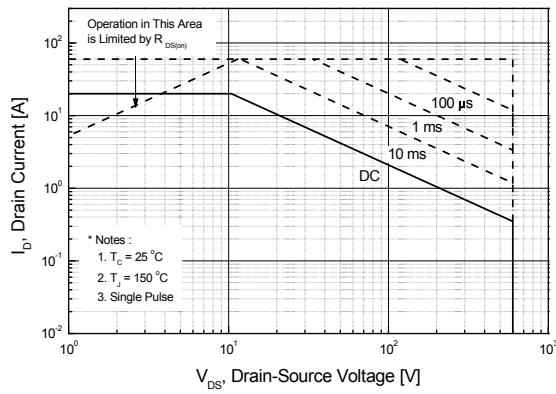


Figure 10. Maximum Drain Current vs. Case Temperature

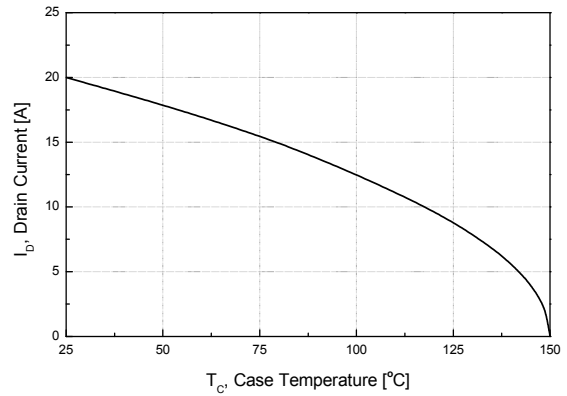


Figure 11. Transient Thermal Response Curve

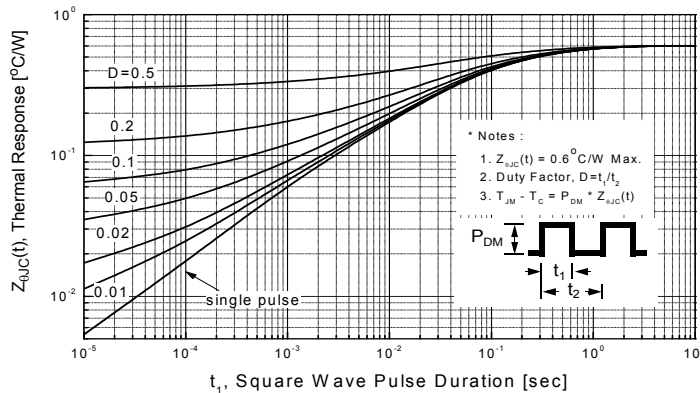


Figure 12. Gate Charge Test Circuit & Waveform

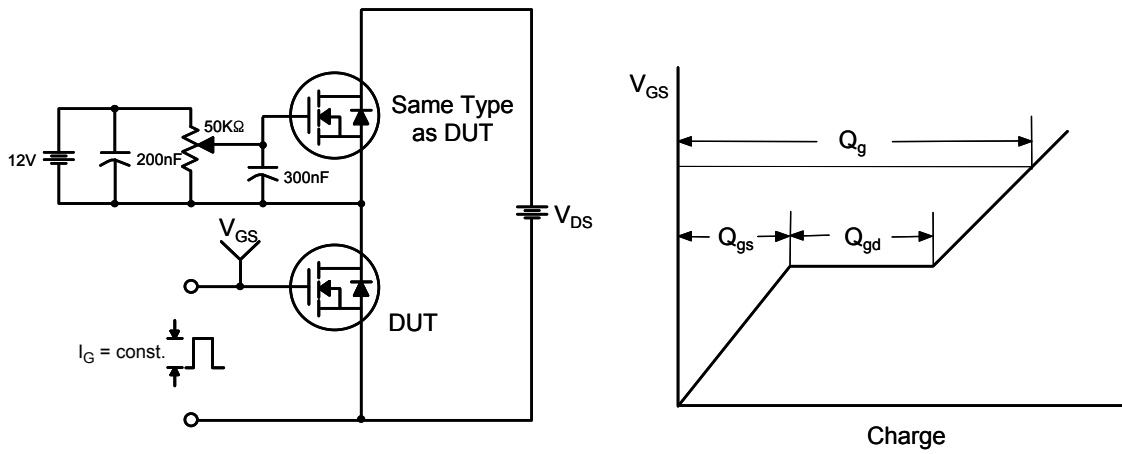


Figure 13. Resistive Switching Test Circuit & Waveforms

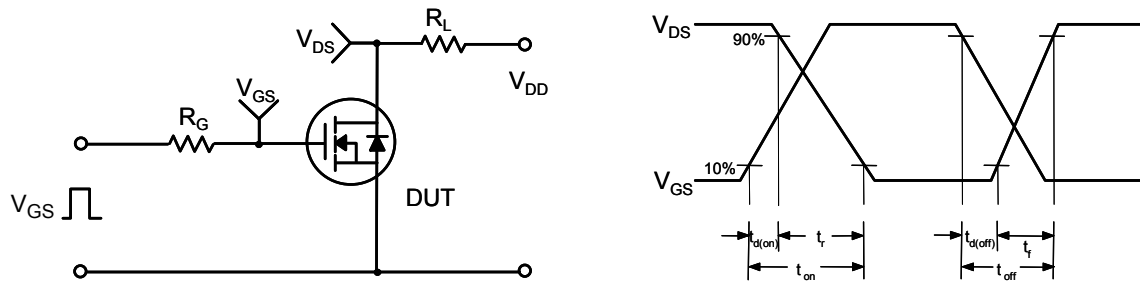


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms



Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms



Mechanical Dimensions

TO-263 2L (D²PAK)

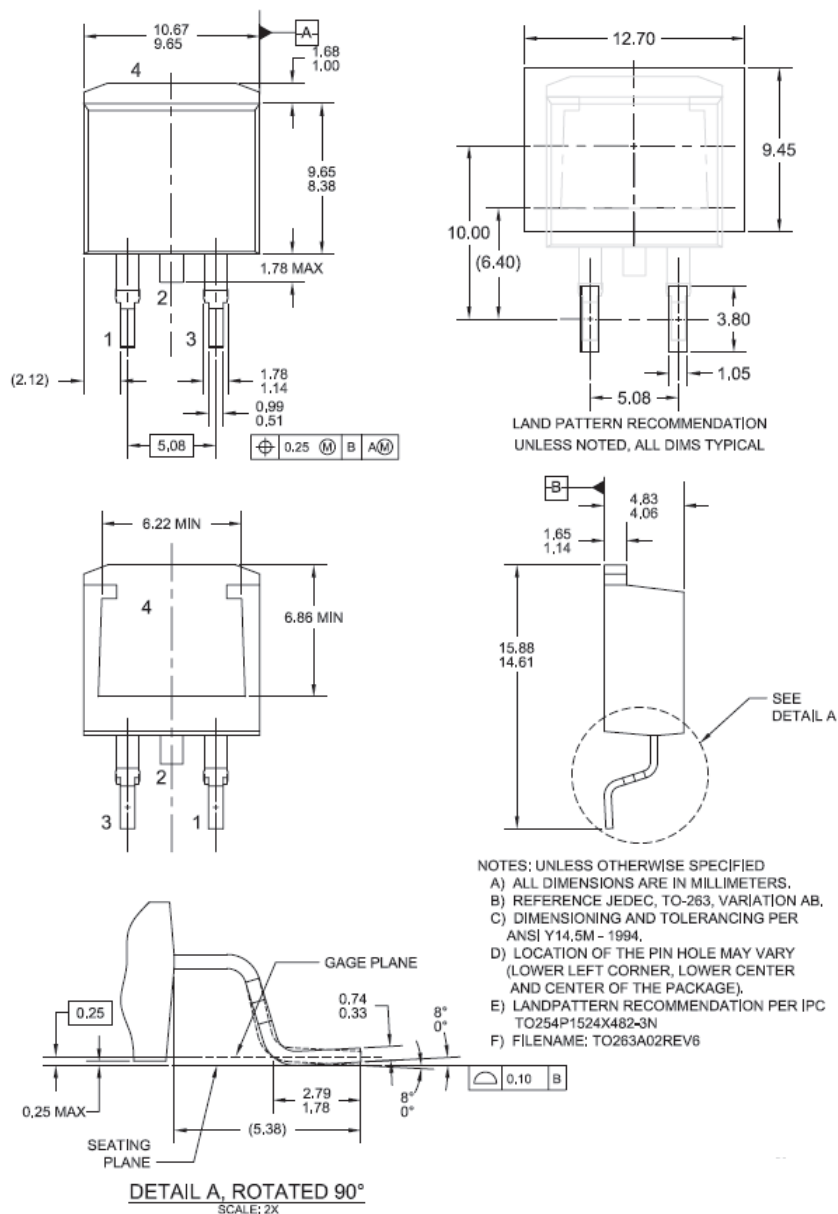


Figure 16. 2LD, TO263, Surface Mount

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Dimension in Millimeters



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